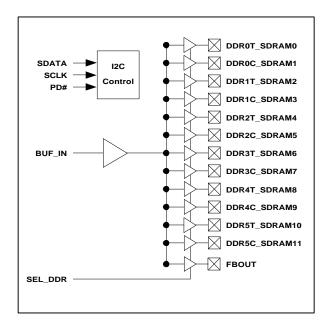


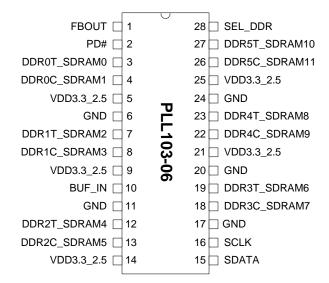
FEATURES

- Generates 12-output buffers from one input.
- Supports up to 2 DDR DIMMS or 3 SDRAM DIMMS.
- Supports 266MHz DDR SDRAM.
- One additional output for feedback.
- Less than 5ns delay.
- Skew between any outputs is less than 100 ps.
- 2.5V or 3.3V Supply range.
- Enhanced DDR and SDRAM Output Drive selected by I2C.
- Available in 28 pin SSOP.

BLOCK DIAGRAM



PIN CONFIGURATION



Note: #: Active Low

DESCRIPTIONS

The PLL103-06 is designed as a 3.3V/2.5V buffer to distribute high-speed clocks in PC applications. The device has 12 outputs. These outputs can be configured to support 3 unbuffered standard SDR (Single Data Rate) DIMMS and 2 DDR DIMMS. The PLL103-06 can be used in conjunction with the PLL202-04 or similar clock synthesizer for the VIA Pro 266 chipset.

The PLL103-06 also has an I2C interface, which can enable or disable each output clock. When power up, all output clocks are enabled (has internal pull up).



PIN DESCRIPTIONS

Name	Number	Туре	Description
FBOUT	1	0	Feedback clock for chipset. Output voltage depends on VDD3.3_2.5V.
BUF_IN	10	ı	Reference input from chipset. 3.3V input for STANDARD SDRAM mode; 2.5V input for DDR-ONLY mode.
PD	2	I	Power Down Control input. When low, it will tri-state all outputs.
SEL_DDR	28	I	Input configure for DDR-ONLY mode or STANDARD SDR mode. 1 = DDR-ONLY mode (when VDD3.3_2.5 select 2.5V); 0 = SDR mode (when VDD3.3_2.5 select 3.3V). In DDR-ONLY mode, all outputs will be configured as DDR outputs. In STANDARD SDR mode, all outputs will be configured as SDRAM outputs.
DDR[0:5]T_SDRAM [0,2,4,6,8,10]	3,7,12,19, 23,27	0	When SEL_DDR=1, these outputs provide DDR mode outputs; when SEL_DDR=0, these outputs provide standard SDRAM mode outputs. Voltage swing depends on VDD3.3_2.5.
DDR[0:5]C_SDRAM [1,3,5,7,9,11]	4,8,13,18, 22,26	0	When SEL_DDR=1, these outputs provide complementary copies of BUF_IN; when SEL_DDR=0, these outputs provide standard SDRAM mode outputs. Voltage swing depends on VDD3.3_2.5.
VDD3.3_2.5	5,9,14,21,25	Р	When VDD=2.5V, SEL_DDR=1. DDR-ONLY mode is selected; when VDD=3.3V, SEL_DDR=0. STANDARD SDRAM mode is selected.
GND	6,11,17, 20,24	Р	Ground.



12C BUS CONFIGURATION SETTING

Address Assignment	A6	A5	A4	А3	A2	A1	Α0	R/W	
Address Assignment	1	1	0	1	0	0	1	_	
Slave Receiver/Transmitter	Provid	les both s	ave write	and readb	ack functi	onality			
Data Transfer Rate	Stand	ard mode	at 100kbi	:s/s					
Data Protocol	This serial protocol is designed to allow both blocks write and read from the controller. The bytes must be accessed in sequential order from lowest to highest byte. Each byte transferred must be followed by 1 acknowledge bit. A byte transferred without acknowledged bit will terminate the transfer. The write or read block both begins with the master sending a slave address and a write condition (0xD2) or a read condition (0xD3).								
Following the acknowledge of this address byte, in Write Mode: the Command Byte Count Byte must be sent by the master but ignored by the slave, in Read Mode: th Count Byte will be read by the master then all other Data Byte. Byte Count Byte do power-up is = (0x09).						: the Byte			

12C CONTROL REGISTERS

1. BYTE 6: Outputs Register (1=Enable, 0=Disable)

Bit	Pin#	Default	Description
Bit 7	28	1	SEL_DDR (I2C is ready only, value is set through pin28)
Bit 6	-	0	Reserved
Bit 5	-	0	Reserved
Bit 4	1	1	FBOUT
Bit 3	27, 26	1	DDR5T_SDRAM10, DDR5C_SDRAM11
Bit 2	-	1	Reserved
Bit 1	23, 22	1	DDR4T_SDRAM8, DDR4C_SDRAM9
Bit 0	-	1	Reserved



2. BYTE 7: Outputs Register (1=Enable, 0=Disable)

Bit	Pin#	Default	Description
Bit 7	-	1	Reserved
Bit 6	19, 18	1	DDR3T_SDRAM6, DDR3C_SDRAM7
Bit 5	12, 13	1	DDR2T_SDRAM4, DDR2C_SDRAM5
Bit 4	-	1	Reserved
Bit 3	-	1	Reserved
Bit 2	7, 8	1	DDR1T_SDRAM2, DDR1C_SDRAM3
Bit 1	-	1	Reserved
Bit 0	3, 4	1	DDR0T_SDRAM0, DDR0C_SDRAM1



ELECTRICAL SPECIFICATIONS

1. Absolute Maximum Ratings

PARAMETERS	SYMBOL	MIN.	MAX.	UNITS
Supply Voltage	V_{DD}	V _{SS} -0.5	7.0	٧
Input Voltage, dc	VI	Vss-0.5	V _{DD} +0.5	V
Output Voltage, dc	Vo	Vss-0.5	V _{DD} +0.5	V
Storage Temperature	T _S	-65	150	°C
Ambient Operating Temperature	TA	0	70	°C
ESD Voltage			2	KV

Exposure of the device under conditions beyond the limits specified by Maximum Ratings for extended periods may cause permanent damage to the device and affect product reliability. These conditions represent a stress rating only, and functional operations of the device at these or any other conditions above the operational limits noted in this specification is not implied.

2. Operating Conditions

PARAMETERS	SYMBOL	MIN.	MAX.	UNITS
Supply Voltage	V _{DD3.3}	3.135	3.465	V
Supply Voltage	V _{DD2.5}	2.375	2.625	V
Input Capacitance	Cin		5	pF
Output Capacitance	Соит		6	pF

3. Electrical Specifications

PARAMETERS	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Input High Voltage	Vih	All Inputs except I2C	2.0		V _{DD} +0.3	V
Input Low Voltage	V _{IL}	All inputs except I2C	V _{SS} -0.3		0.8	V
Input High Current	Іін	V _{IN} = V _{DD}			TBM	uA
Input Low Current	I _{IL}	V _{IN} = 0			TBM	uA
Output High Voltage	V _{OH}	IOL = -12mA, VDD = 2.375V	1.7			V
Output Low Voltage	VoL	IOL = 12mA, VDD = 2.375V			0.6	V
Output High Current	Іон	VDD = 2.375V, VOUT=1V	-18	-32		mA
Output Low Current	loL	VDD = 2.375V, VOUT=1.2V	26	35		mA

Note: TBM: To be measured



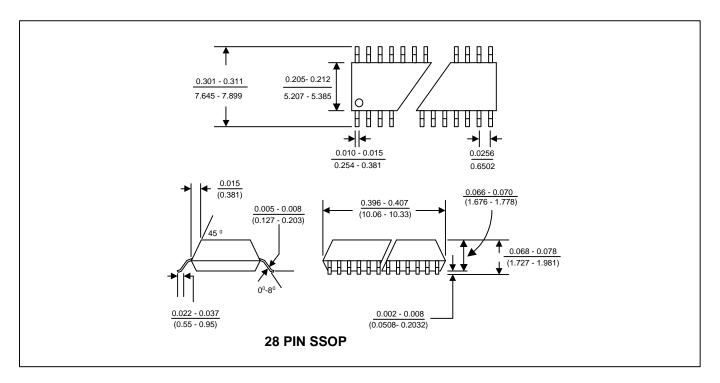
3. Electrical Specifications (Continued)

PARAMETERS	SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNITS
Supply Current (DDR-only mode)	I _{DD}	Unloaded outputs, 133MHz			ТВМ	mA
Supply Current (SDRAM mode)	I _{DD}	Unloaded outputs, 133MHz			ТВМ	mA
Supply Current	I _{DDS}	PD = 0			TBM	mA
Output Crossing Voltage	Voc		(VDD/2) -0.1	VDD/2	(VDD/2)+ 0.1	V
Output Voltage Swing	Vouт		0.7		VDD-0.4	V
Duty Cycle	Dτ	Measured @ 1.5V	45	50	55	%
Max. Operating Frequency			66		170	MHz
Rising Edge Rate	T _{OR}	Measured @ 0.4V ~ 2.4V	1.0	1.5	2.0	V/ns
Falling Edge Rate	Tof	Measured @ 2.4V ~ 0.4V	1.0	1.5	2.0	V/ns
DDR Rising Edge Rate	Tor	Measured between 20% to 80% of output	0.25	0.6	1.0	V/ns
DDR Falling Edge Rate	Tof	Measured between 20% to 80% of output	0.25	0.6	1.0	V/ns
Clock Skew(pin to pin)	Tskew	All outputs equally loaded			100	ps
Stabilization Time	T _{ST}				0.1	ms

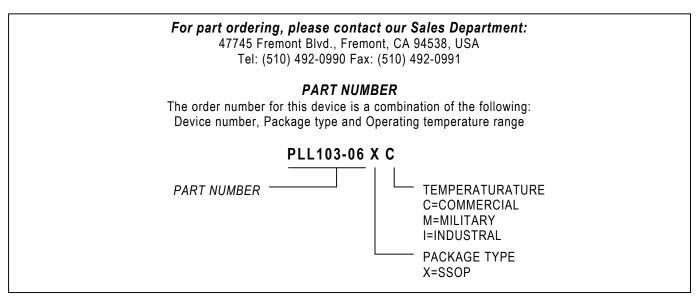
Note: TBM: To be measured



PACKAGE INFORMATION



ORDERING INFORMATION



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